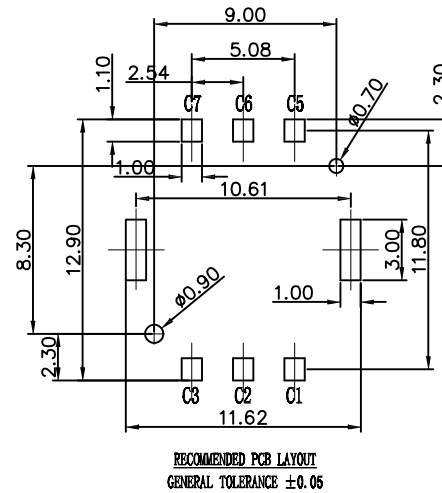
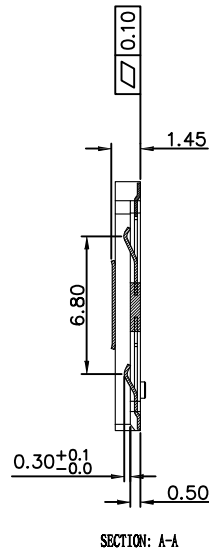
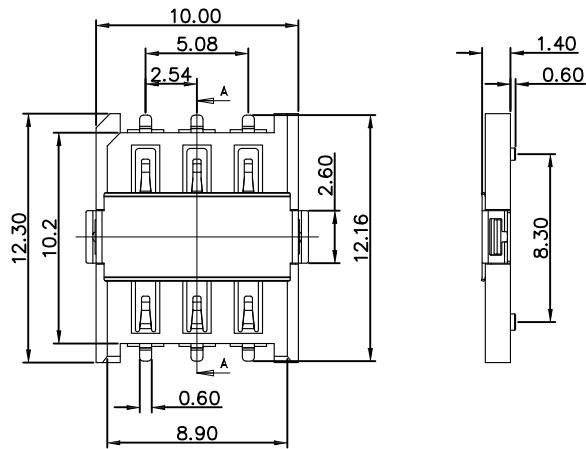
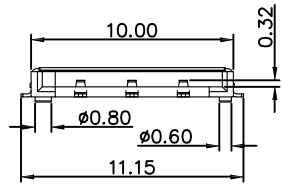


1 RoHS Compliance



Notes:

1. Material:

Housing: LCP 30%GF, UL94V-0, Black
 Contact : Phosphor Bronze, T=0.15mm
 Shell: SUS201-H, T=0.15mm

2. Plating:

Contact:

Contact Area: 1U/3U*GOLD PLATED
 Solder Area: G/F Gold
 Underplating: Ni overall 40u" Min.

Shell:

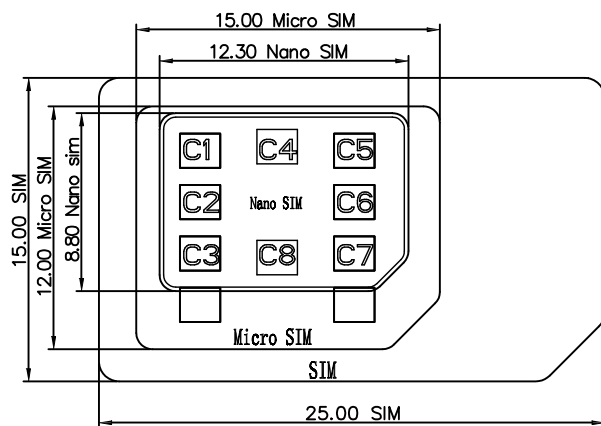
Solder Area: G/F Gold
 Underplating: Ni overall 40u"

3. Mechanical:

Life cycles: 5000.

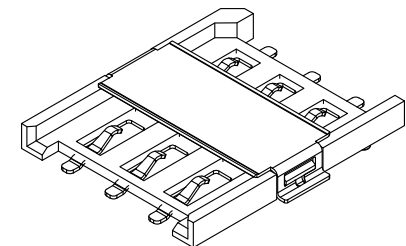
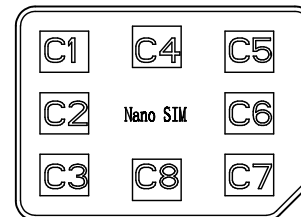
4. Electrical:

Voltage Rating: 30V AC RMS
 Current Rating: 0.5A AC RMS Max
 Operating Temperature: -20° C to +80° C
 Dielectric Withstanding Voltage: 100V AC (60Sec Min)
 Insulation Resistance: 1000MΩ Min
 Contact Resistance: 30mΩ Max



Nano SIM Card
 REFERENCE DATA

- C1 --> VCC
- C2 --> RST
- C3 --> CLK
- C5 --> GND
- C6 --> VPP
- C7 --> I/O



| ANGLE TOLERANCE | | PROJECTION | | Description: | |
|-------------------|-------|------------|--------|---------------------------------------|--|
| ±3° | | | | Nano SIM CARD CONNECTOR 6PIN SMT TYPE | |
| GENERAL TOLERANCE | | UNITS | mm | KLS P/N: L-KLS1-SIM-113-6P-H1.45-R | |
| x.x | ±0.30 | SHEET SIZE | A4 | NingBo KLS ELECTRONIC CO.,L.TD. | |
| x.xx | ±0.20 | Draw: | Daniel | | |
| x.xxx | ±0.10 | Check: | Daniel | | |